Product data sheet

1. General description

Planar passivated Silicon Controlled Rectifier (SCR) in a TO263 (D2PAK) surface mountable plastic package intended for use in applications requiring very high inrush current capability, high thermal cycling performance and high junction temperature capability ($T_{i(max)}$ = 150 °C).

2. Features and benefits

- · High bidirectional blocking voltage capability
- · High junction operating temperature capability
- · High thermal cycling performance
- · Planar passivated for voltage ruggedness and reliability
- · Surface mountable package
- · Very high current surge capability

3. Applications

- Capacitive Discharge Ignition (CDI)
- Crowbar protection
- Inrush protection
- Motor control
- · Voltage regulation

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Values			Unit	
V_{RRM}	repetitive peak reverse voltage		600				V
I _{T(AV)}	average on-state current	half sine wave;T _{mb} ≤ 129 °C; <u>Fig 1</u>	12.7			А	
$I_{T(RMS)}$	RMS on-state current	half sine wave;T _{mb} ≤ 129 °C; <u>Fig 2</u> ; <u>Fig 3</u>	20			А	
I _{TSM}	non-repetitive peak on- state current	half sine wave; $T_{j(init)} = 25 \text{ °C}$; $t_p = 10 \text{ ms}$; Fig 4; Fig 5				А	
		half sine wave; $T_{j(init)} = 25 \text{ °C}$; $t_p = 8.3 \text{ ms}$				Α	
T _j	junction temperature		150		°C		
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static cha	racteristics						
I _{GT}	gate trigger current	$V_D = 12 \text{ V}; I_T = 0.1\text{A}; T_j = 25 \text{ °C};$ Fig 7		-	4.5	32	mA
Dynamic o	characteristics						

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
dV _D /dt	rate of rise of off-state	V_{DM} = 402 V; T_j = 150 °C; exponential	1000	-	-	V/µs
	voltage	waveform; gate open circuit				

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode		
2	А	anode		A → K
3	G	gate		G sym037
mb	A	mounting base; connected to anode		

6. Ordering information

Table 3. Ordering information

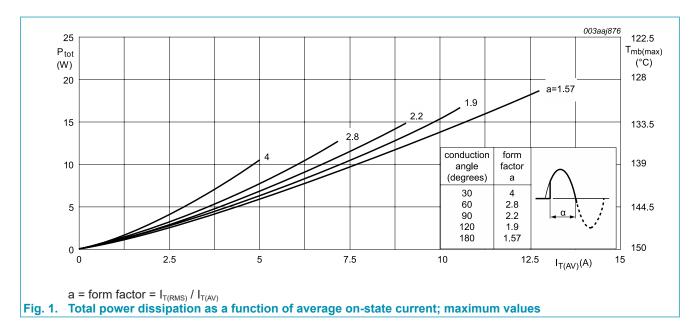
able of Gracining information									
Type number	Package	Orderable part number	Packing	Small packing	Package	Package			
	Name		method	quantity	version	issue date			
TYN20B-600T	TO263	TYN20B-600TJ	Reel	800	TO263E	26-May-2017			

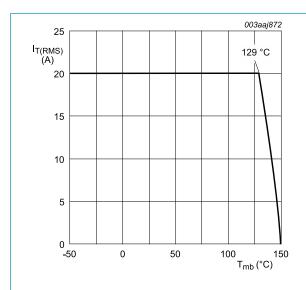
7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V_{DRM}	repetitive peak off-state voltage		600	V
V_{RRM}	repetitive peak reverse voltage		600	V
I _{T(AV)}	average on-state current	half sine wave; T _{mb} ≤ 129 °C; <u>Fig 1</u>	12.7	Α
I _{T(RMS)}	RMS on-state current	half sine wave; T _{mb} ≤ 129 °C; <u>Fig 2</u> ; <u>Fig 3</u>	20	Α
I _{TSM}	non-repetitive peak on- state current	half sine wave; $T_{j(init)} = 25 \text{ °C}$; $t_p = 10 \text{ ms}$; Fig 4; Fig 5	210	Α
		half sine wave; $T_{j(init)} = 25 \text{ °C}$; $t_p = 8.3 \text{ ms}$	231	А
l ² t	I ² t for fusing	t _p = 10 ms; sine-wave pulse	220.5	A ² s
dl _⊤ /dt	rate of rise of on-state current	I _G = 70 mA	100	A/µs
I _{GM}	peak gate current		5	А
V_{RGM}	peak reverse gate voltage		5	V
P_{GM}	peak gate power		20	W
$P_{G(AV)}$	average gate power	over any 20 ms period	1	W
T _{stg}	storage temperature		-40 to 150	°C
T _j	junction temperature		150	°C





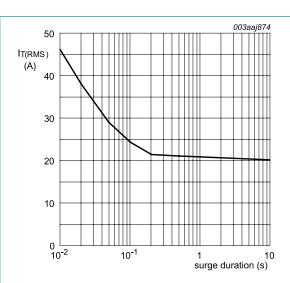


Fig. 2. RMS on-state current as a function of mounting base temperature; maximum values

f = 50 Hz; T_{mb} =129 °C

Fig. 3. RMS on-state current as a function of surge duration; maximum values

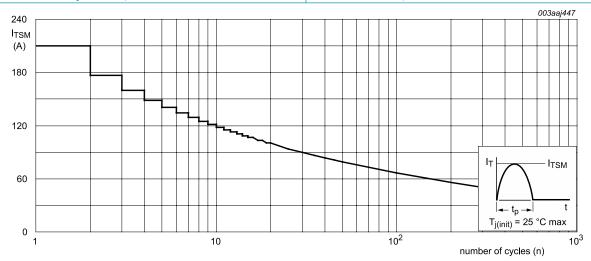
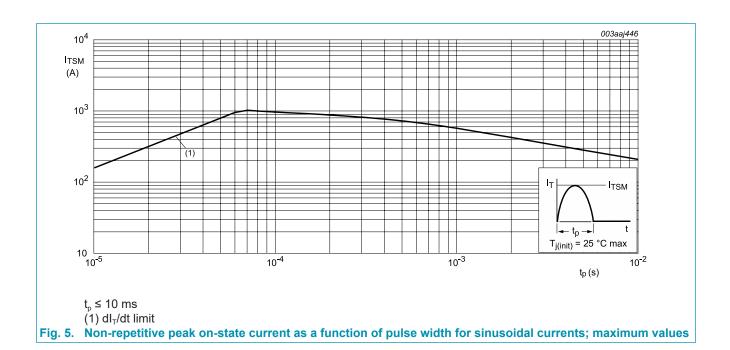


Fig. 4. Non-repetitive peak on-state current as a function of the number of sinusoidal current cycles; maximum values

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8. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	Fig. 6	-	-	1.1	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	minimum footprint, FR4 board	-	55	-	K/W

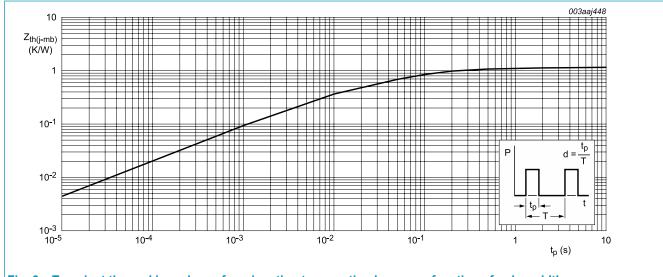


Fig. 6. Transient thermal impedance from junction to mounting base as a function of pulse width

9. Characteristics

Table 6. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
I _{GT}	gate trigger current	$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T_j = 25 \text{ °C}; Fig. 7$	-	4.5	32	mA
IL	latching current	$V_D = 12 \text{ V}; I_G = 0.1 \text{ A}; T_j = 25 \text{ °C}; Fig. 8$	-	21	60	mA
I _H	holding current	V _D = 12 V;T _j = 25 °C; <u>Fig. 9</u>	-	16	40	mA
V _T	on-state voltage	I _T = 32 A; T _j = 25 °C; <u>Fig. 10</u>	-	1.2	1.5	V
V_{GT}	gate trigger voltage	$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T_j = 25 \text{ °C}; Fig. 11$	-	0.7	1.3	V
		$V_D = 400V; I_T = 0.1 A; T_j = 150 °C$	0.2	0.4	-	V
I _D	off-state current	V _D = 600 V; T _j = 150 °C	-	0.2	1	mA
I _R	reverse current	V _R = 600 V; T _j = 150 °C	-	0.2	1	mA
Dynamic	characteristics				•	
dV _D /dt	rate of rise of off-state voltage	V _{DM} = 402 V; T _j = 150 °C; exponential waveform; gate open circuit	1000	-	-	V/µs

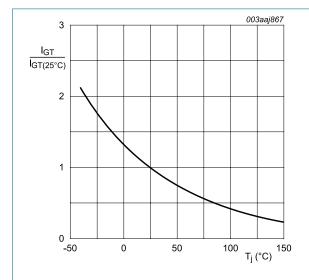


Fig. 7. Normalized gate trigger current as a function of junction temperature

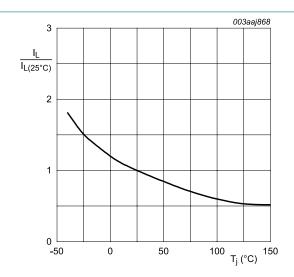
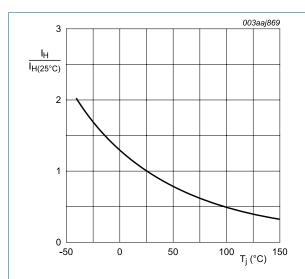
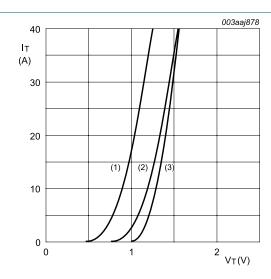


Fig. 8. Normalized latching current as a function of junction temperature





 V_o = 1.0485 V; R_s = 0.0133 Ω (1) T_j = 150 °C; typical values (2) T_j = 150 °C; maximum values (3) T_j = 25 °C; maximum values

Fig. 9. Normalized holding current as a function of junction temperature

Fig. 10. On-state current as a function of on-state voltage

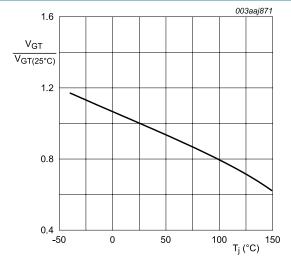
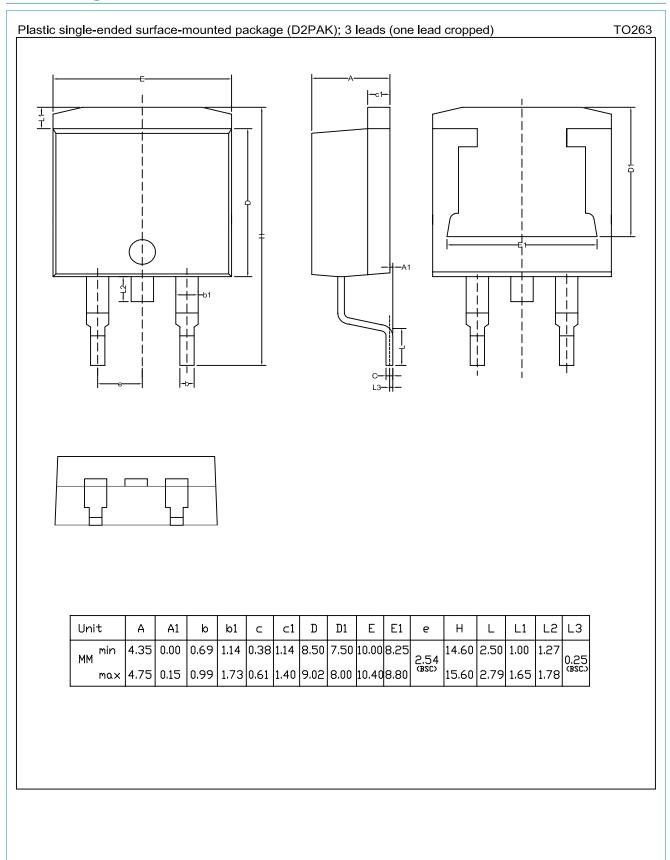


Fig. 11. Normalized gate trigger voltage as a function of junction temperature

10. Package outline



11. Legal information

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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